

Applications

- General Purpose Wideband Gain Block
- Electronic Warfare
- Military & Commercial Radar
- Military Communications
- Commercial Communications
- Instrumentation

Product Features

- Frequency Range: 2 – 30 GHz
- Small Signal Gain: 10 dB typical
- Return Loss: 12 dB typical
- NF: 4.0 dB mid-band
- P1dB: 19 dBm, $P_{SAT} = 19$ dBm at $P_{IN} = 10$ dBm
- OTOI: > 25 dBm at $P_{out}/tone = 8$ dBm
- Bias: $V^+ = 10.4$ V, $I_{DQ} = 135$ mA, $V_{CTRL} = 2.2$ V, $V_G = -1$ V Typical
- Package Dimensions: 5 x 5 x 1.5 mm

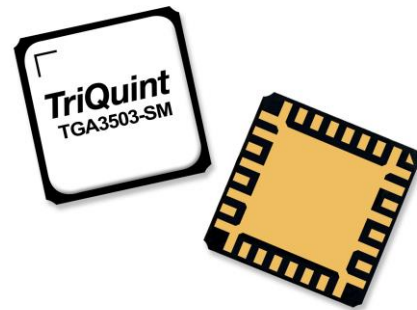
General Description

TriQuint's TGA3503-SM is a wideband gain block with adjustable gain control giving the user extra flexibility to fine tune system performance. Operating from 2 to 30GHz, the TGA3503-SM provides 19dBm P1dB and 10dB of small-signal gain with return losses of greater than 12dB.

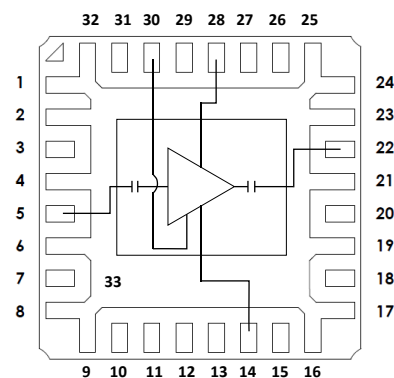
The TGA3503-SM is fabricated on TriQuint's production TQPHT15 0.15um GaAs pHEMT process and is offered in a robust, 5x5mm ceramic air-cavity QFN. With integrated DC blocking caps and fully match to 50ohms, the TGA3503-SM is easily integrated in both commercial and military system architectures.

Lead-free and RoHS compliant

Evaluation Boards are available upon request.



Functional Block Diagram



Pad Configuration

| Pad No. | Symbol |
|------------------------------------|--------------------------------------|
| 1-4, 6-13, 15-21, 23-27, 29, 31-32 | Gnd |
| 5 | RF _{IN} |
| 14 | V _G |
| 22 | RF _{OUT} |
| 28 | V ⁺ |
| 30 | V _{CTRL} or V _{G2} |
| 33 | Gnd |

Ordering Information

| Part | ECCN | Description |
|------------|-------|-------------------------------------|
| TGA3503-SM | EAR99 | 2 – 30 GHz GaAs Wideband Gain Block |

Absolute Maximum Ratings

| Parameter | Value (1) |
|---|---------------|
| Bias Voltage (V^+) | 10.4 V |
| Drain Voltage (V_D) | 6 V (2) |
| Gate Voltage Range (V_G) | -3 to 0 V |
| Control Voltage Range (V_{CTRL}) | -3 to 3 V |
| Drain Current (I_D) | 150 mA |
| Gate Current (I_G) | -2 to 10 mA |
| Power Dissipation, 85 °C (P_{DISS}) | 1.4 W |
| Input Power, CW, 50 Ω , (P_{IN}) | 21 dBm |
| Channel temperature (T_{CH}) | 200 °C |
| Mounting Temperature (30 Seconds) | 260 °C |
| Storage Temperature | -55 to 150 °C |

Notes:

1. Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.
2. Assure $V_D - V_{CTRL} \leq 8$ V. Compute $V_D = V^+ - I_{DQ} \cdot 40$

Recommended Operating Conditions

| Parameter | Value |
|-------------------------------------|--------------|
| Supply Voltage (V^+) | 10.4 V |
| Drain Voltage (V_D) | 5 V |
| Drain Current (I_{DQ}) | 135 mA |
| Gate Voltage (V_G) | -1 V Typical |
| Gain Control Voltage (V_{CTRL}) | 2.2 V |
| Temperature (T_{BASE}) | -40 to 85 °C |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: 25 °C, $V^+ = 10.4$ V, $I_{DQ} = 135$ mA, $V_{CTRL} = 2.2$ V, $V_G = -1$ V Typical, CW

| Parameter | Min | Typical | Max | Units |
|---------------------------------------|-----|---------|-----|-------|
| Operational Frequency Range | 2 | | 30 | GHz |
| Small Signal Gain | | 10 | | dB |
| Input Return Loss | | 12 | | dB |
| Output Return Loss | | 12 | | dB |
| Noise Figure (at mid-band) | | 4 | | dB |
| Output Power at 1 dB Gain Compression | | 19 | | dBm |
| Output TOI at Pout/tone = 8 dBm | | > 25 | | dBm |
| Gain Temperature Coefficient | | -0.01 | | dB/°C |

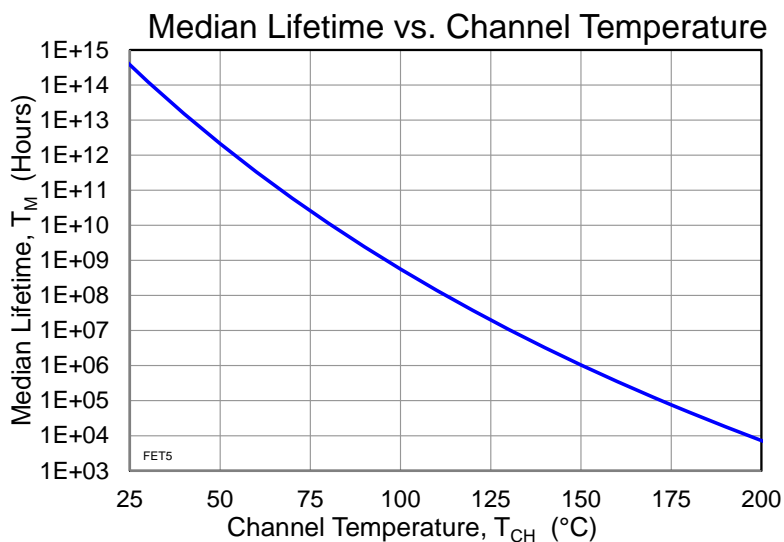
Thermal and Reliability Information

| Parameter | Test Conditions | Value | Units |
|---|---|-------------------|------------------------------------|
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{base} = 85\text{ }^{\circ}\text{C}$, $V^+ = 10.4\text{ V}$, $V_D = 5\text{ V}$, $V_{CTRL} = 2.2\text{ V}$, $I_{DQ} = 135\text{ mA}$, $P_{DISS} = 0.7\text{ W}$ | 30 | $^{\circ}\text{C}\cdot\text{mm/W}$ |
| Channel Temperature (T_{CH}) (no RF drive) | | 105 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | | 2.8×10^8 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{base} = 85\text{ }^{\circ}\text{C}$, $V^+ = 10.4\text{ V}$ (CW), $V_{ds} = 5\text{ V}$, $I_{DQ} = 135\text{ mA}$, $I_{D_DRIVE} = 142\text{ mA}$, $P_{IN} = 10\text{ dBm}$, $P_{OUT} = 19\text{ dBm}$, $\text{Freq} = 16\text{ GHz}$, $P_{DISS} = 0.62\text{ W}$ | 30 | $^{\circ}\text{C}\cdot\text{mm/W}$ |
| Channel Temperature (T_{CH}) (with RF drive) | | 105 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | | 2.8×10^8 | Hrs |

Notes:

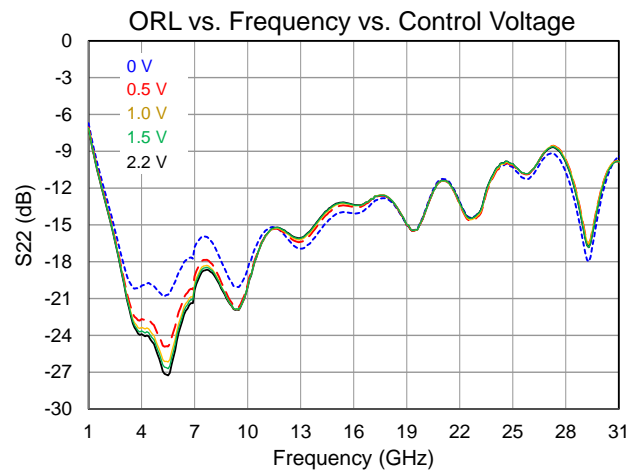
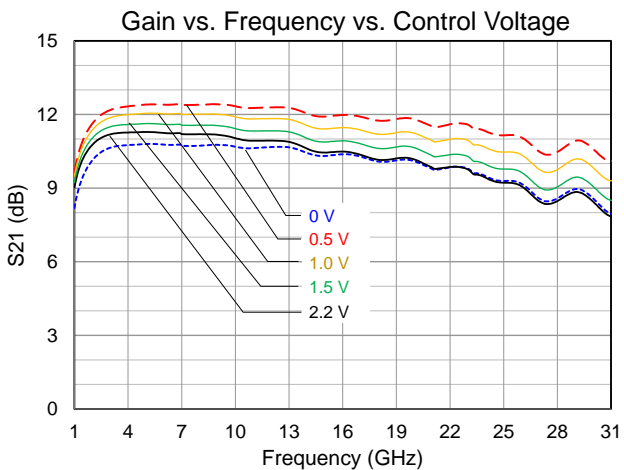
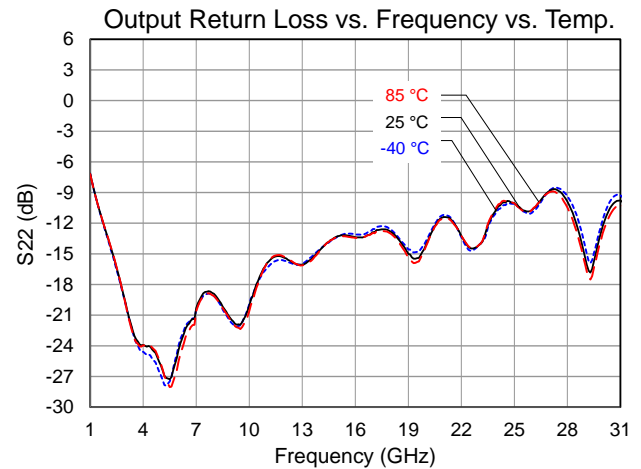
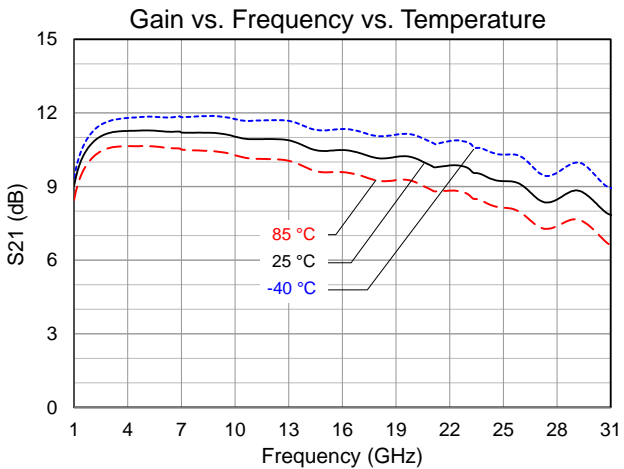
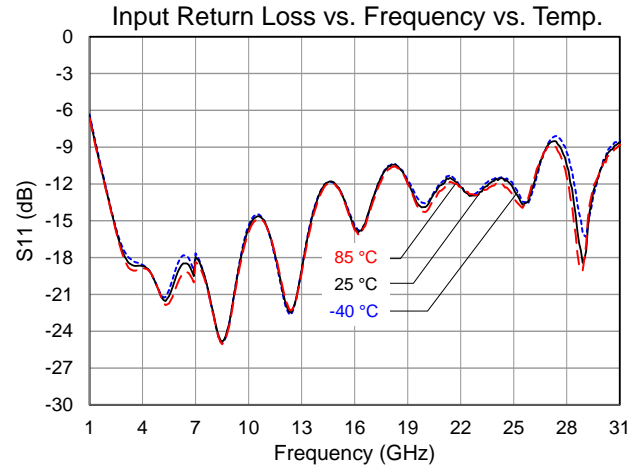
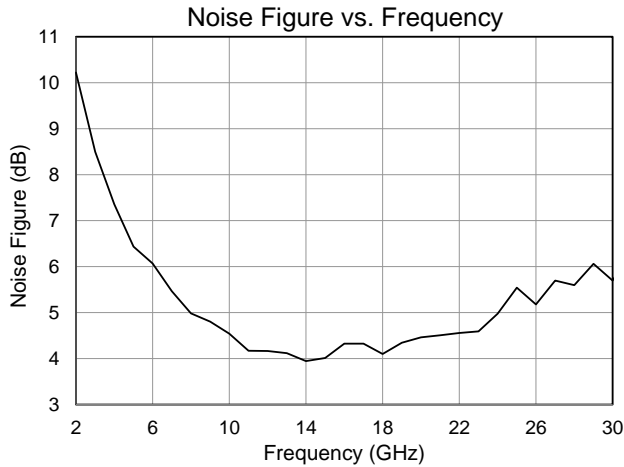
1. Thermal resistance measured at back of the package.

Test Conditions: $V_D = 6\text{ V}$; Failure Criteria is 10% reduction in I_{D_MAX}



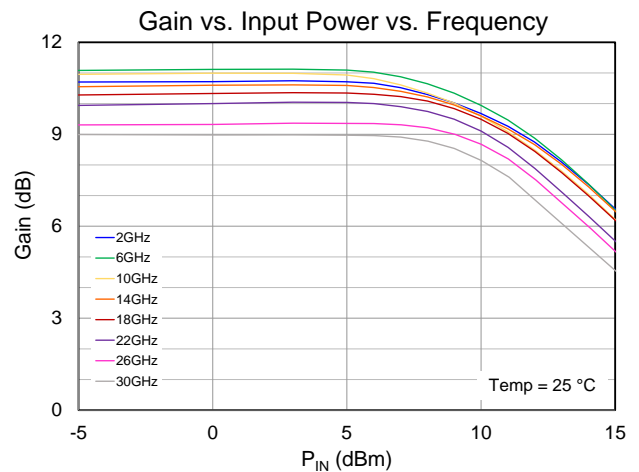
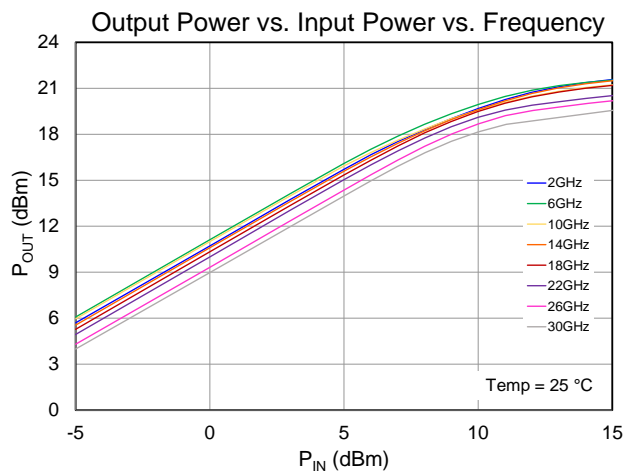
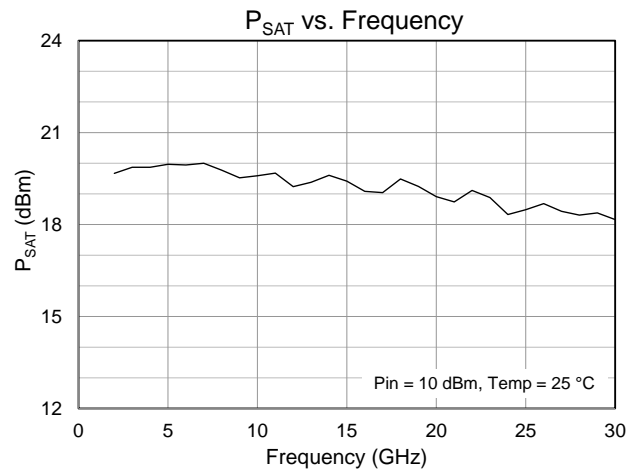
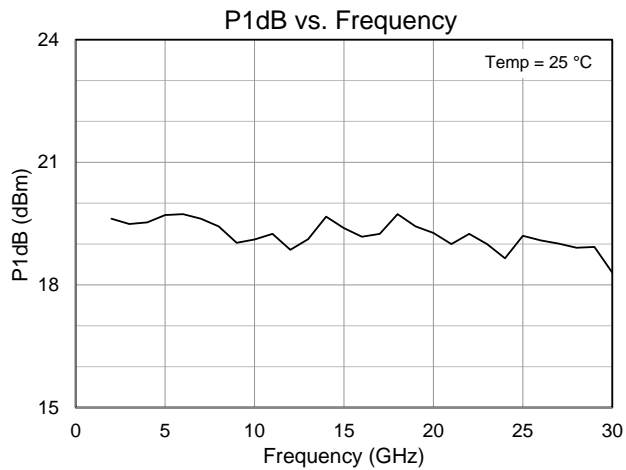
Typical Performance: Small Signal

Conditions unless otherwise specified: $V^+ = 10.4\text{ V}$, $I_{BQ} = 135\text{ mA}$, $V_{CTRL} = 2.2\text{ V}$, $V_G = -1\text{ V}$ Typical, CW, 25 °C



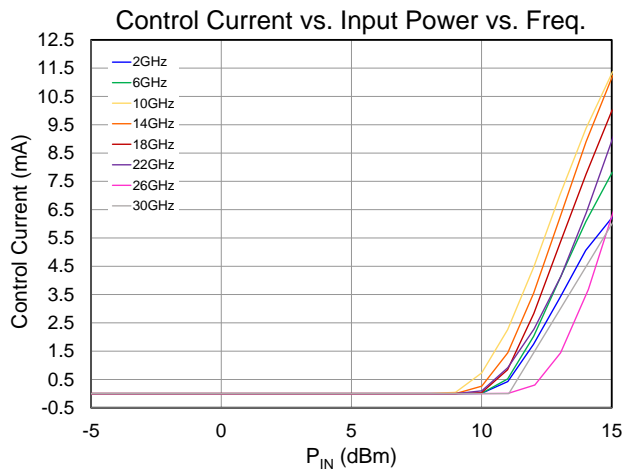
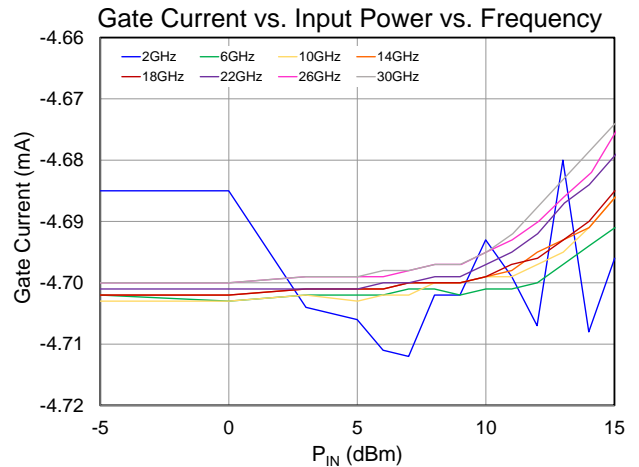
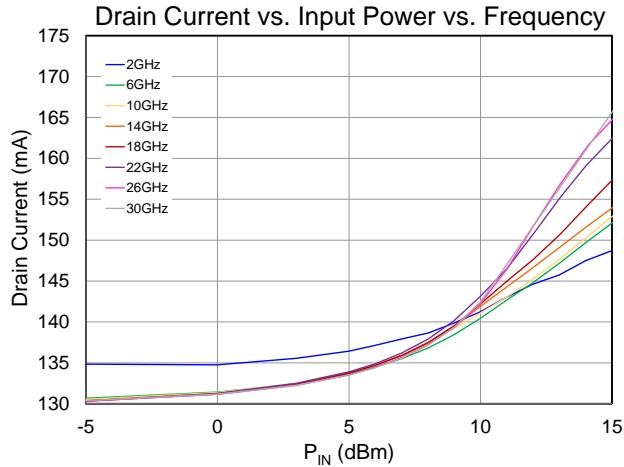
Typical Performance: Large Signal

Conditions unless otherwise specified: $V^+ = 10.4\text{ V}$, $I_{DQ} = 135\text{ mA}$, $V_{CTRL} = 2.2\text{ V}$, $V_G = -1\text{ V}$ Typical, CW, $25\text{ }^\circ\text{C}$



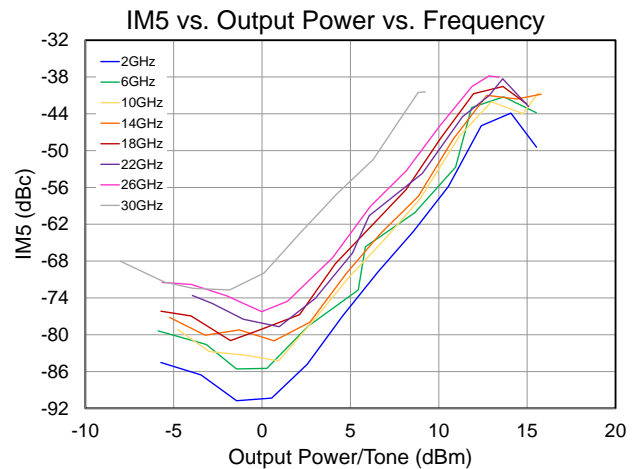
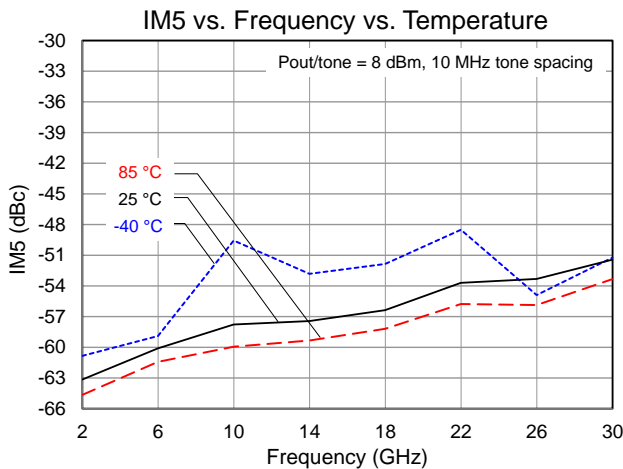
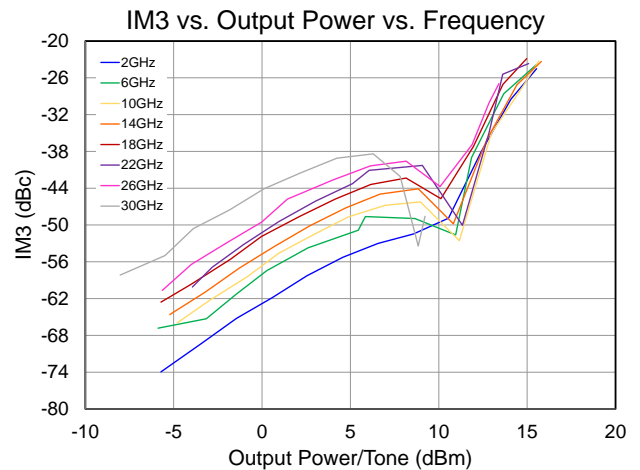
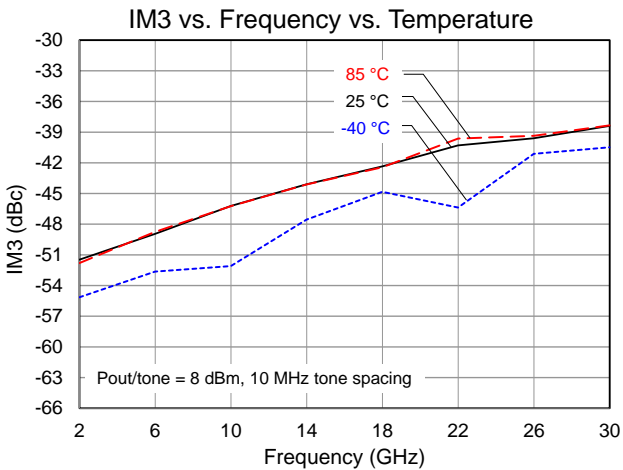
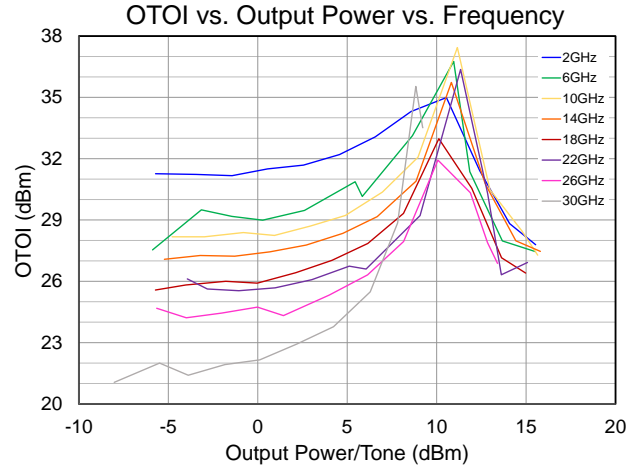
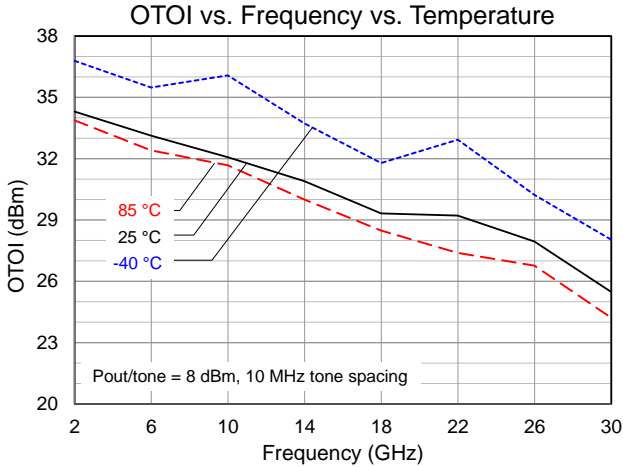
Typical Performance: Large Signal

Conditions unless otherwise specified: $V^+ = 10.4\text{ V}$, $I_{DQ} = 135\text{ mA}$, $V_{CTRL} = 2.2\text{ V}$, $V_G = -1\text{ V}$ Typical, CW, $25\text{ }^\circ\text{C}$

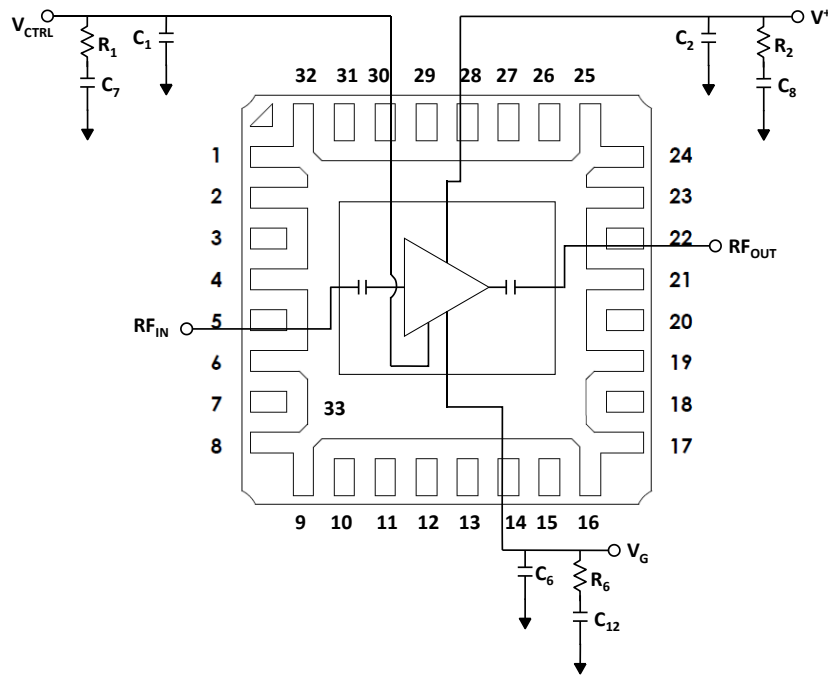


Typical Performance: Linearity

Conditions unless otherwise specified: $V^+ = 10.4\text{ V}$, $I_{DQ} = 135\text{ mA}$, $V_{CTRL} = 2.2\text{ V}$, $V_G = -1\text{ V}$ Typical, CW, 25 °C



Application Information



Bias-up Procedure

1. Set I_D limit to 150 mA, I_G limit to 10 mA
2. Apply -3 V to V_G for pinch off
3. Apply desired value to V_{CTRL}
4. Apply +5 V to V^+
5. Set V_G more positive until $I_{DQ} = 100$ mA ($V_G \sim -1$ V Typical)
5. Adjust V^+ to +10.4V, resulting in $V_D = 5$ V
7. Adjust V_G for $I_{DQ} = 135$ mA
8. Apply RF signal

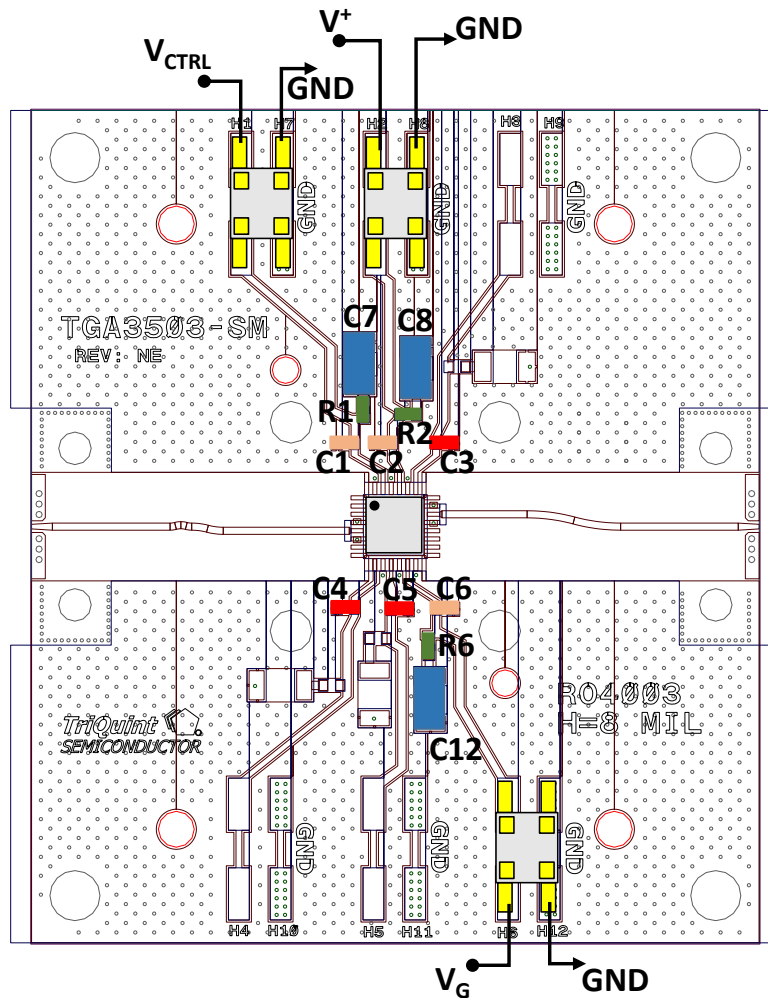
Bias-down Procedure

1. Turn off RF signal
2. Reduce V_G to set I_{DQ} to 100 mA.
3. Set V^+ to 5 V
4. Reduce V_G to -3 V. Ensure $I_{DQ} \sim 0$ mA
5. Turn off V_{CTRL} supply
6. Set V^+ to 0 V
7. Turn off V_G supply

Pin Description

| Pin No. | Symbol | Description |
|------------------------------------|------------------------|--|
| 1-4, 6-13, 15-21, 23-27, 29, 31-32 | Gnd | Recommend grounding on PCB |
| 5 | RF _{IN} | Input; matched to 50 Ω; DC blocked |
| 14 | V_G | Gate voltage; bias network is required; see recommended Application Information above. |
| 22 | RF _{OUT} | Output; matched to 50 Ω; DC blocked |
| 28 | V_+ | Drain voltage; bias network is required; see recommended Application Information above. |
| 30 | V_{CTRL} or V_{G2} | Gain control voltage; bias network is required; see recommended Application Information above. |
| 33 | Gnd | Ground Paddle. Multiple vias should be employed to minimize inductance and thermal resistance. |

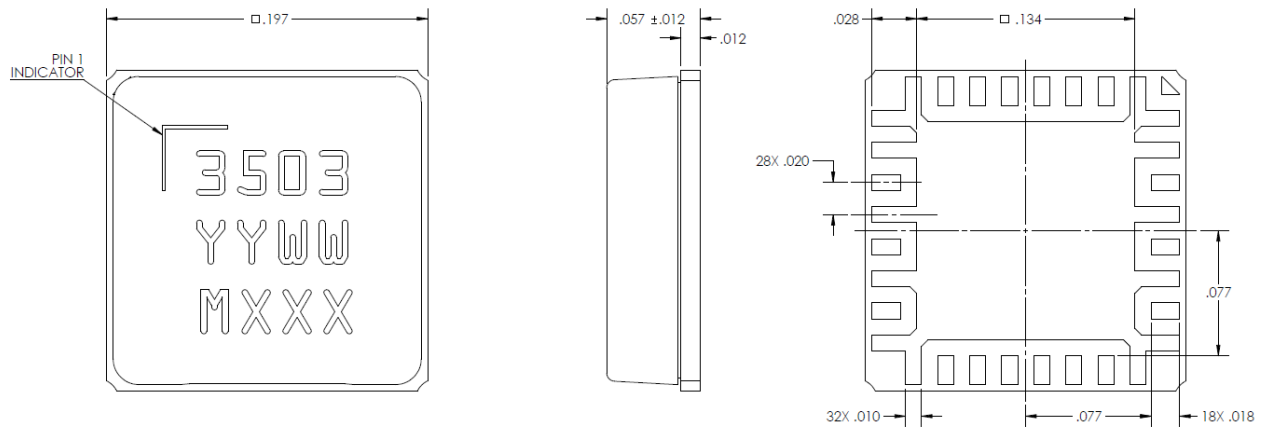
Evaluation Board



Bill of Material

| Reference Des. | Value | Description | Manuf. | Part Number |
|----------------|-------------|---|---------|-------------|
| C1, C2, C6 | 1 μ F | Cap, 0402, 50 V, 10%, X7R | Various | |
| C3, C4, C5 | 0 Ohms | Res, 0402, 5% (Required for above EVB design) | Various | |
| C7, C8, C12 | 2.2 μ F | Res, 1206, 50 V, 10%, X7R | Various | |
| R1, R2, R6 | 15 Ohms | Res, 0402, 50 V, 5% | Various | |

Mechanical Information



Units: inches

Tolerances: unless specified

x.xx = ± 0.01

x.xxx = ± 0.005

Materials:

Base: Aluminum Nitride

All metalized features are Au plated

Part is mold encapsulated

Marking:

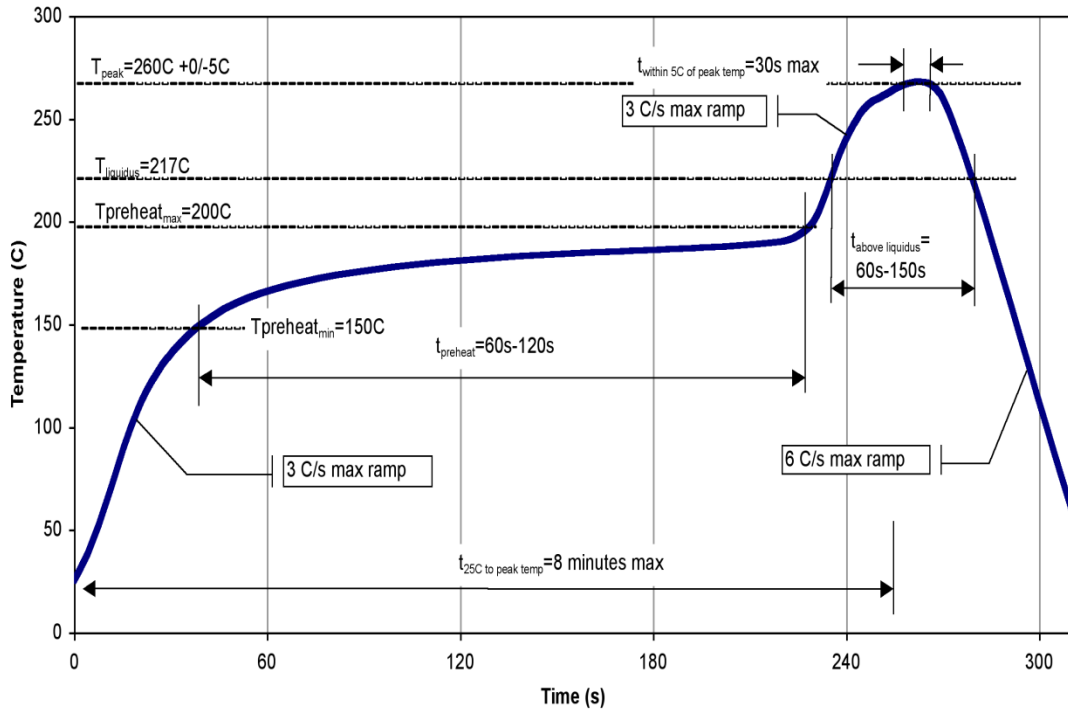
3503: Part number

YY: Part Assembly year

WW: Part Assembly week

MXXX: Batch ID

Recommended Soldering Temperature Profile



Product Compliance Information

ESD Sensitivity Ratings



Caution! ESD-Sensitive Device

ESD Rating: TBD
Value: TBD
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

MSL Rating

Level TBD at TBD°C convection reflow
The part is rated Moisture Sensitivity Level TBD
at TBD°C per JEDEC standard IPC/JEDEC J-STD-020.

ECCN

US Department of Commerce: EAR99

Solderability

Compatible with the latest version of J-STD-020 Lead-free solder, 260 °C.

RoHS Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

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